## Substitute for form 1449A/PTO (modified) **Application Number** 09/990604 **Filing Date** November 21, 2001 **INFORMATION DISCLOSURE First Named Inventor** STATEMENT BY APPLICANT Brady, John T. Art Unit 1712 (Use as many sheets as necessary) **Examiner Name** AUG 1 3 2004 Daniel S. Metzmaier Page 1 of Attorney Case Number 57029US002

U.S. Patent Documents					CLASS	Subclass
Exam. Init.*	Cite No.	Document Number	Publication Date or Issue Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Reges, Column	Lines, Where
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